



Business Result for Second Quarter : 6 months from April to September 2008

(Billions of Yen)	FY2008 Result First 2Qs	FY2009 Result First 2Qs	Year on Year Change (%)	FY2009 Forecast released on Aug.1	Difference from Forecast (Billions of Yen)
Sales	49.9	31.8	△36.2%	32.0	△0.19
Semiconductor	38.2	19.2	△49.6%	19.5	△0.27
Metrology	11.7	12.6	7.6%	12.5	0.08
Operating Income	5.90	2.13	△63.9%	2.40	△0.27
Semiconductor	2.93	△0.56	—	—	—
Operating Income Ratio	7.7%	—	—	—	—
Metrology	2.97	2.69	△9.4%	—	—
Operating Income Ratio	25.4%	21.4%	—	—	—
Ordinary Income	5.96	2.57	△56.9%	2.40	0.17
Net Income	3.35	△0.19	—	△0.40	0.21



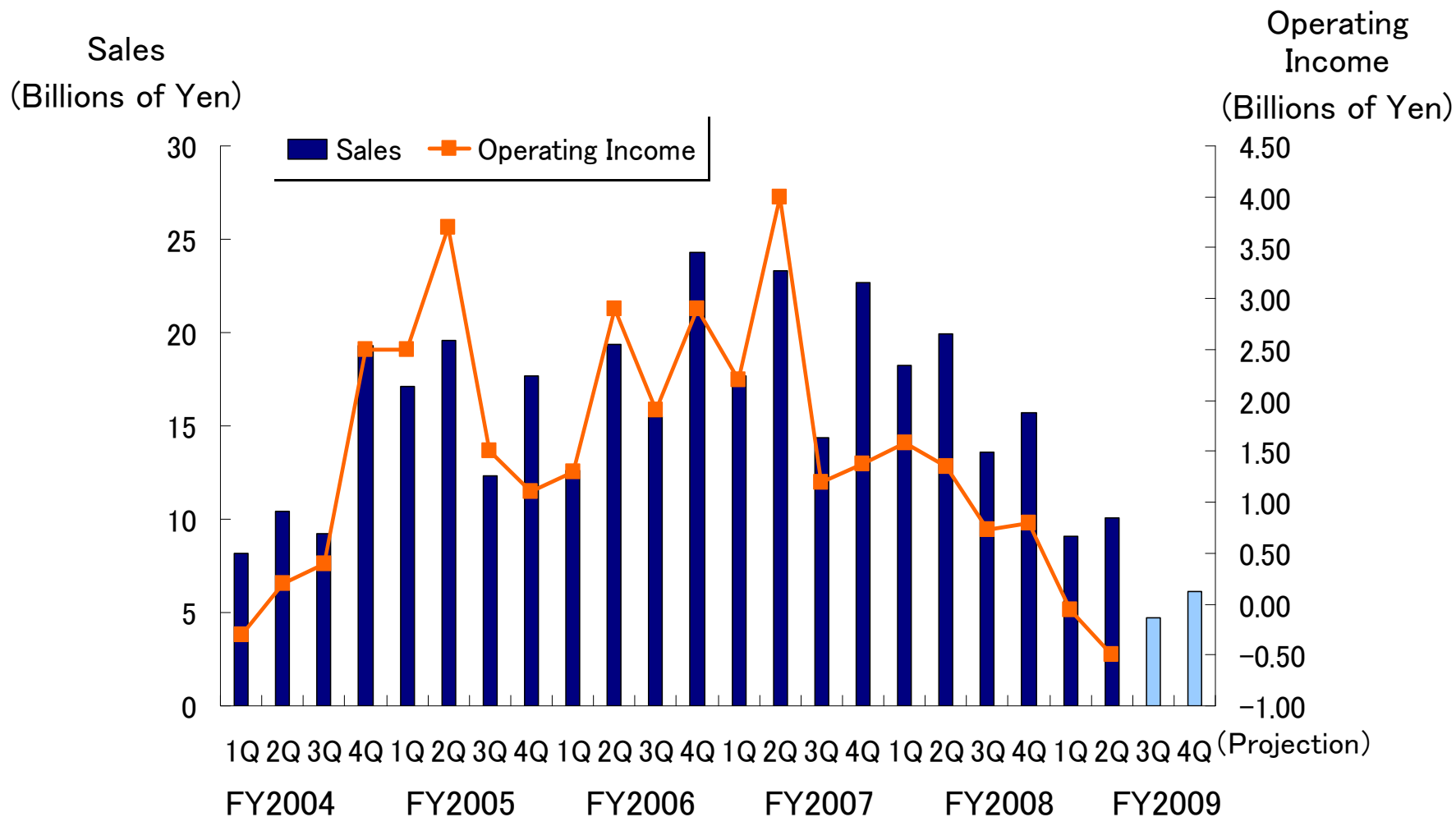
Business Result for Second Quarter : 3 months

(Total of 3 months,
Billions of Yen)

	FY2008				FY2009			
	1Q	2Q	3Q	4Q	1Q	2Q Latest forecast	2Q Results	Year on Year Change
Sales	23.1	26.8	19.5	22.5	14.9	1.71	1.69	△37.0%
Semiconductor	18.2	20.0	13.6	15.7	9.1	1.04	10.1	△49.4%
Metrology	4.9	6.8	5.9	6.8	5.8	6.7	6.8	△0.3%
Operating Income	2.69	3.21	1.97	2.58	1.22	1.18	0.91	△71.7%
Semiconductor	1.58	1.35	0.73	0.79	△0.06	—	△0.50	—
Operating Income Ratio	8.7%	6.8%	5.4%	5.0%	—	—	—	—
Metrology	1.10	1.86	1.24	1.79	1.28	—	1.40	△24.7%
Operating Income Ratio	22.6%	27.4%	21.3%	26.2%	22.1%	—	20.6%	—
Ordinary Income	2.93	3.04	1.86	1.55	1.74	0.66	0.83	△72.7%
Net Income	1.54	1.81	0.91	0.56	△0.62	0.22	0.44	△75.7%

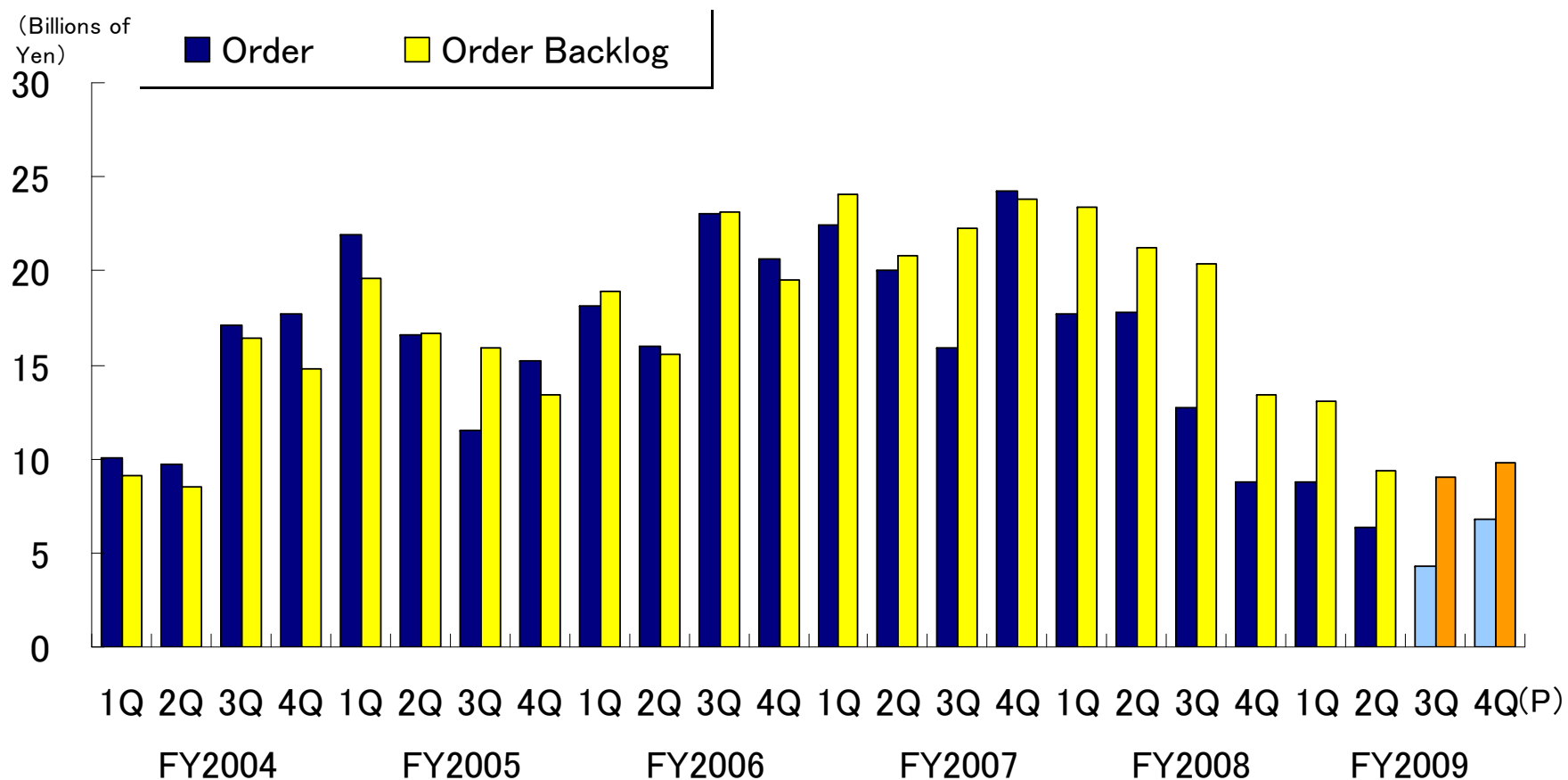


Trend of Semiconductor Business



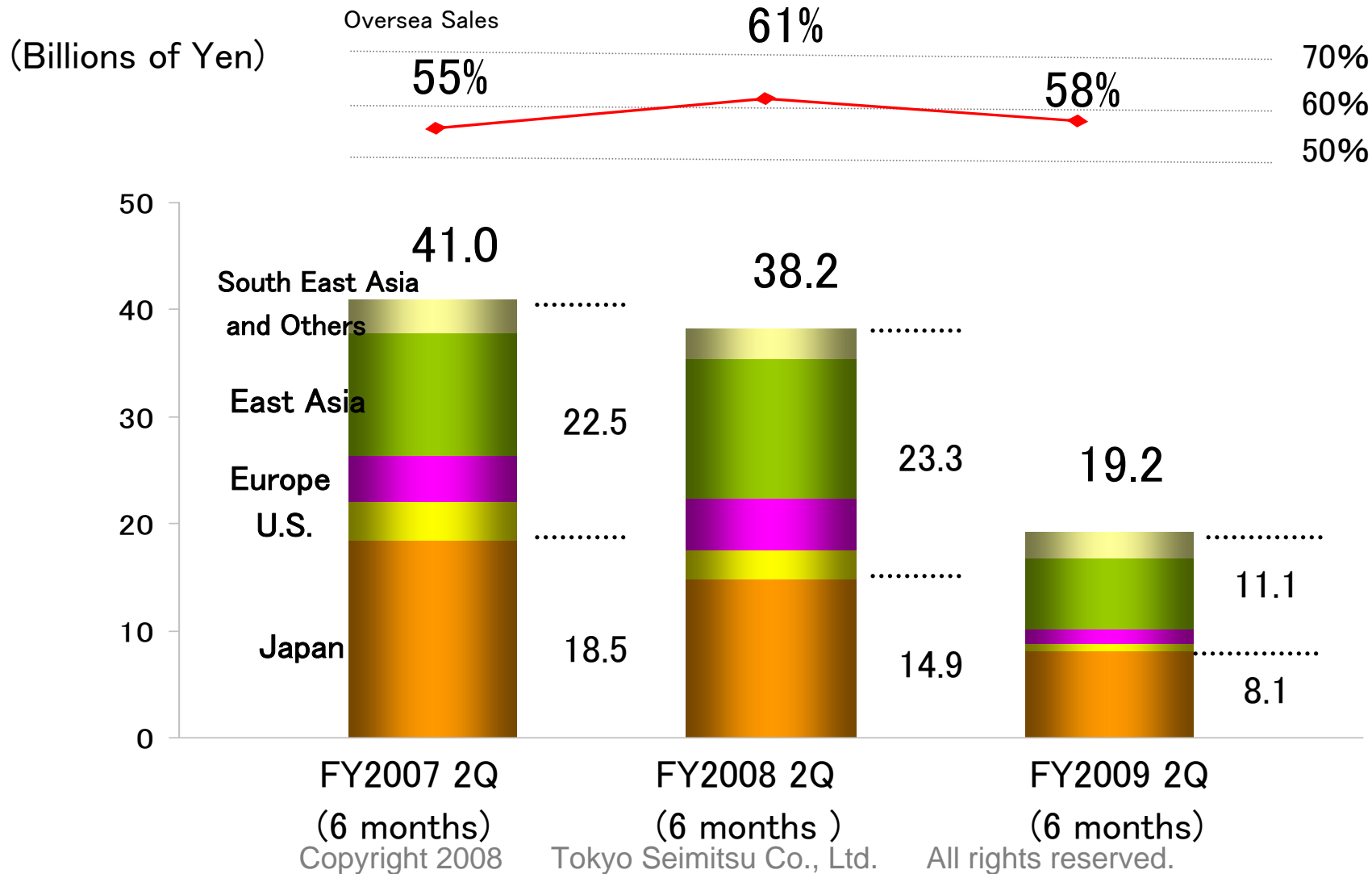


Order of Semiconductor Business



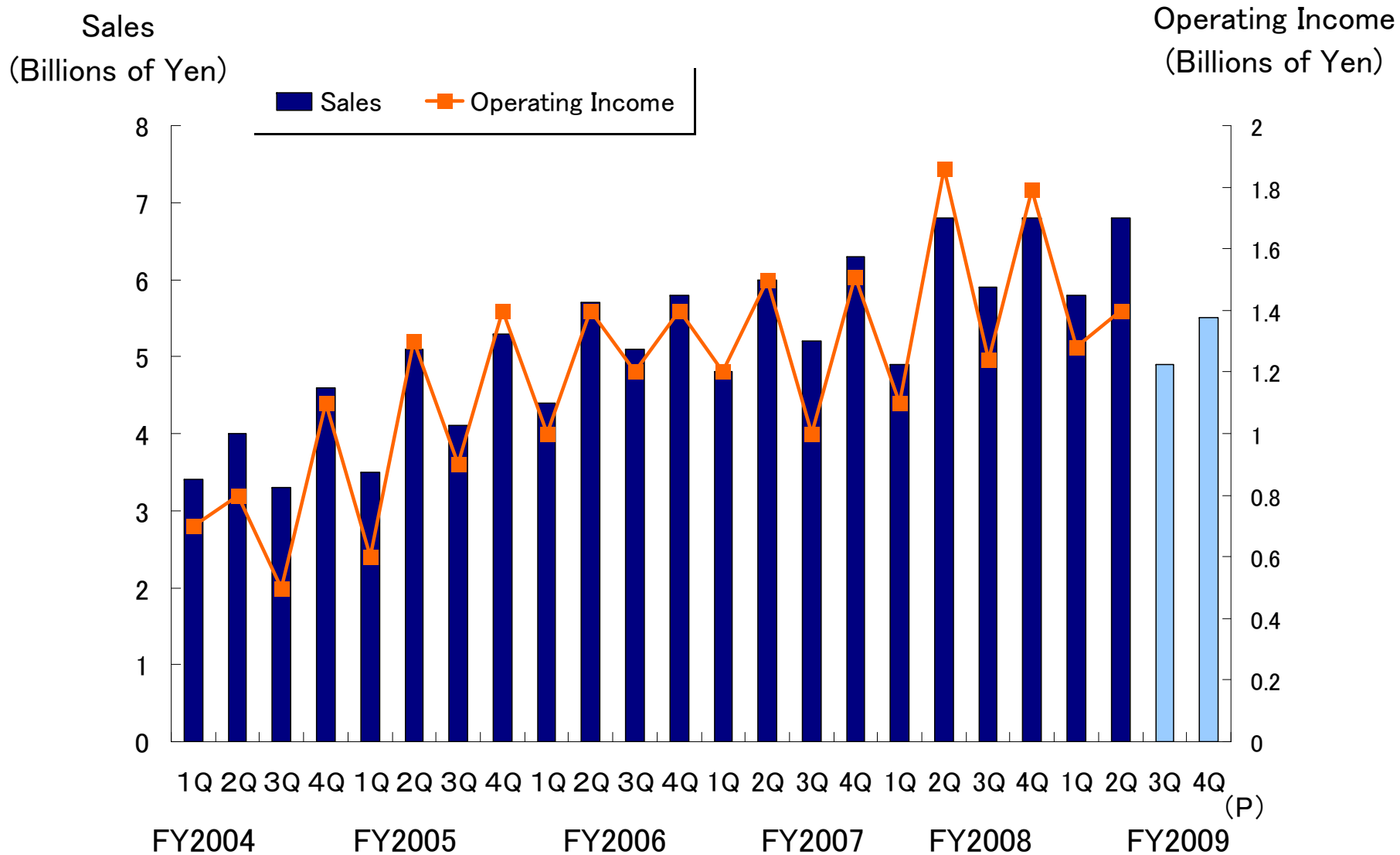


Semiconductor / Regional Sales



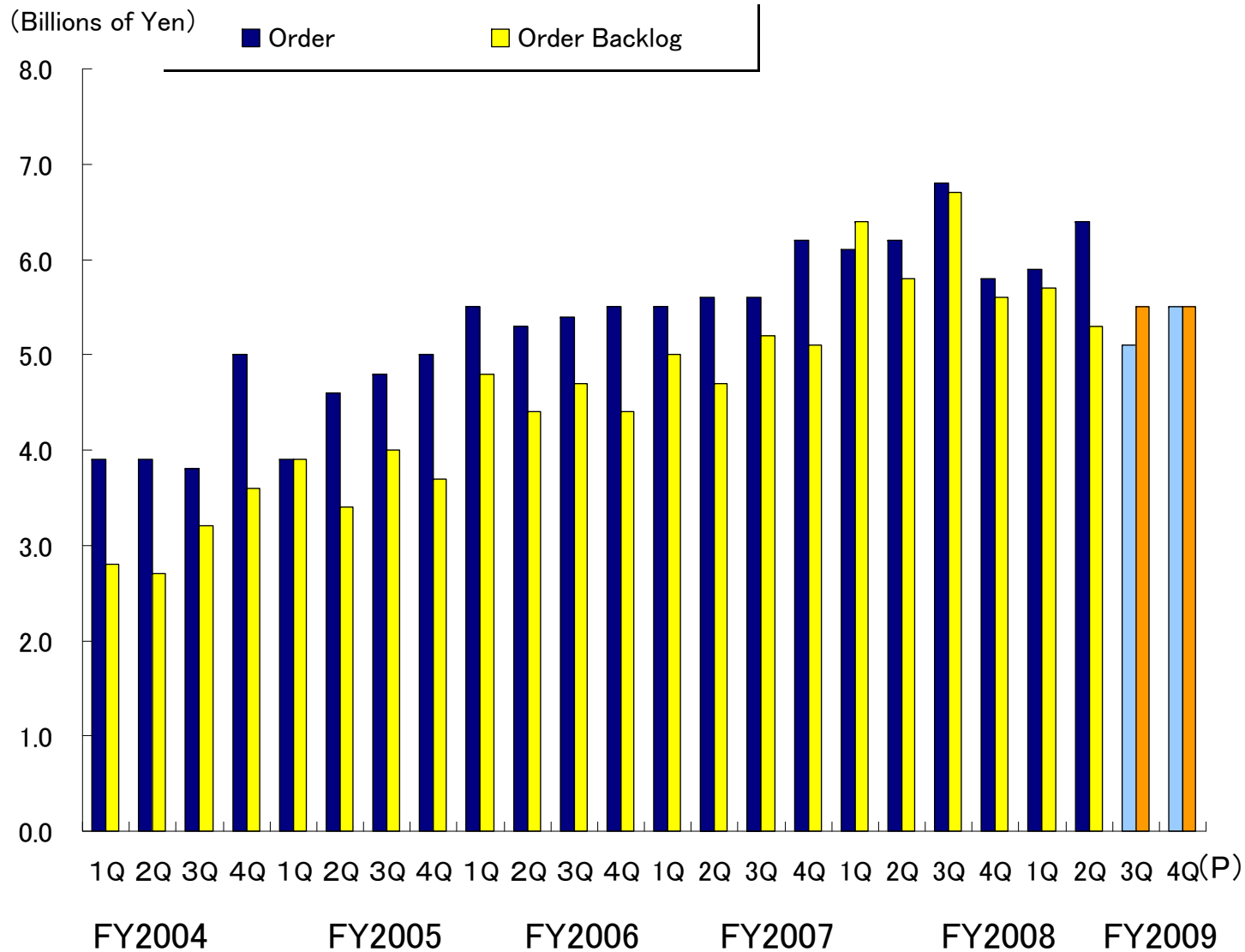


Trend of Measuring Business



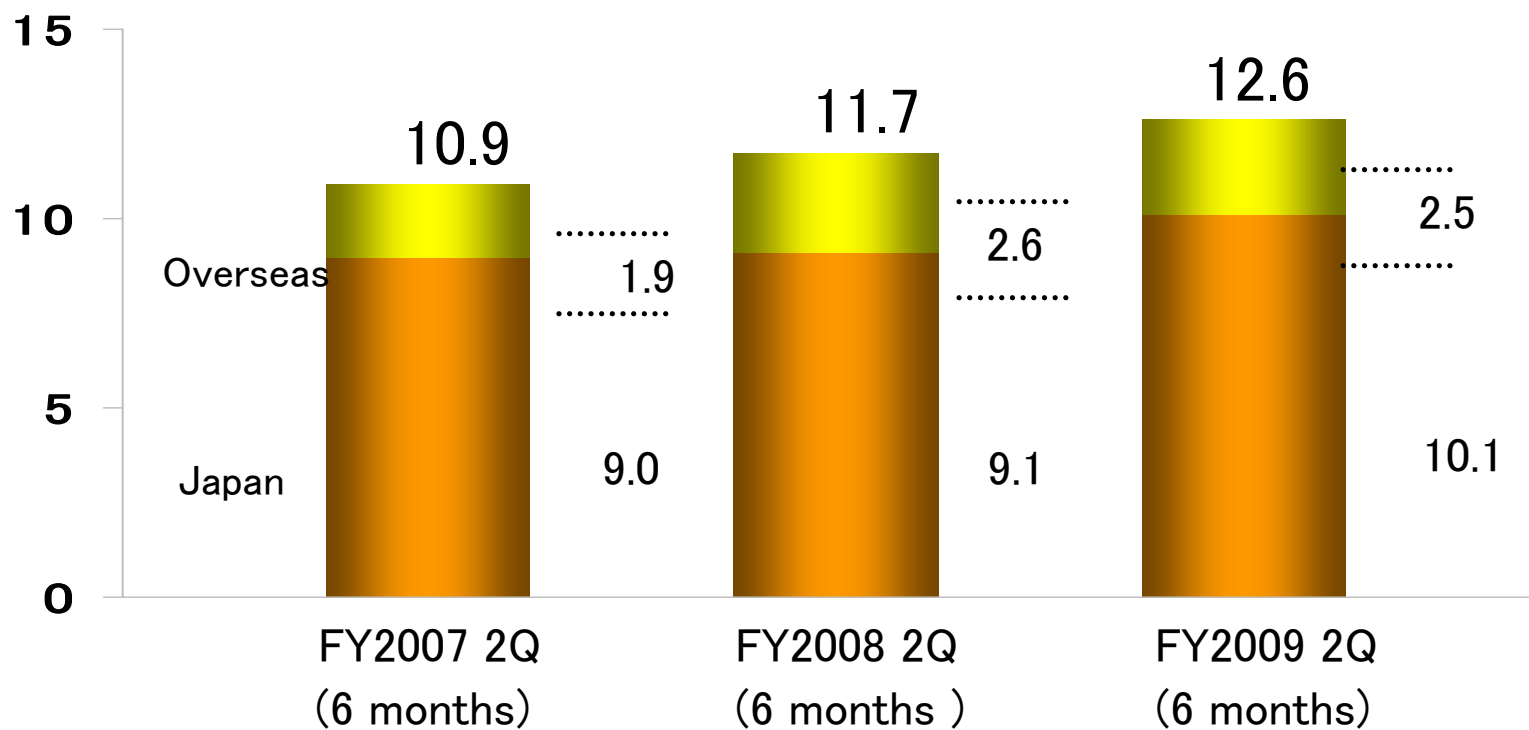
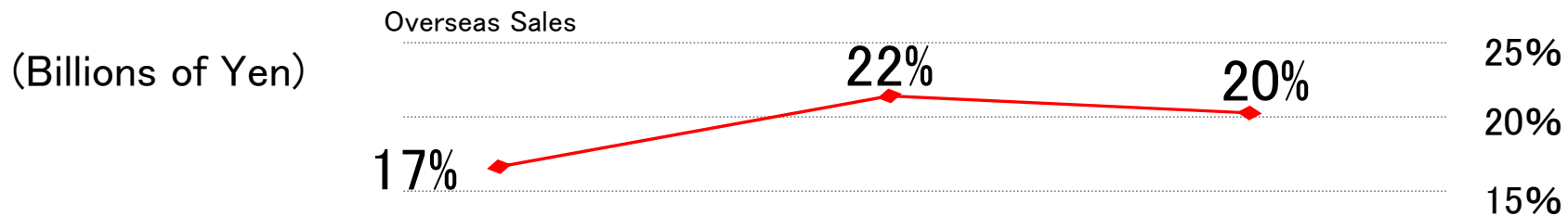


Order of Measuring Business





Measuring/ Regional Sales





Balance Sheet

(Billions of Yen)

Assets	3/08	9/08	Difference	Liabilities/ Net Assets	3/08	9/08	Difference
Cash & Cash Equivalents	15.7	16.7	1.0	Account Payable	19.5	14.3	△5.2
				Bond-Debt	18.5	17.5	△1.0
				Other	6.5	5.6	△0.9
Account Receivable	32.3	26.2	△6.1	Total Current Liabilities	44.5	37.4	△7.1
Inventories	27.7	25.4	△2.3	Total Fixed Liabilities	7.7	11.0	3.3
Other	1.9	2.4	0.5	Total Liabilities	52.2	48.5	△3.7
Total Current Assets	77.6	70.7	△6.9	Net Assets	55.5	53.2	△2.3
Fixed Assets	30.1	31.0	0.9	Total (Int. bearing debt)	107.7 (21.9)	101.7 (23.8)	△6.0 (1.9)
Total Assets	107.7	101.7	△6.0				



Cash Flow for 6 months (April to September 2008)

(Billions of Yen)		FY2007 2Q	FY2008 2Q	FY2009 2Q
Opening Balance		13.8	16.8	15.7
From Operating Activities	Income before Tax, Interest & Depreciation	10.0	7.2	1.3
	Decrease in Receivables, Inventories + Increase in Payables	△ 6.1	1.9	3.0
	Tax Payments	△ 1.1	△ 3.5	△ 2.0
	Others	2.1	△ 1.1	0
	Total	4.9	4.5	2.3
From Investing Activities		△ 1.5	△ 3.6	△ 1.3
Free Cash Flow		3.4	0.9	1.0
From Financial Activities	Increase in Borrowings	0.9	△ 1.8	1.7
	Dividend & other	△ 0.7	△ 1.0	△ 1.6
	Total	△ 1.5	△ 2.8	0.1
Cash Increase		1.9	△ 1.8	1.0
Closing Balance		15.7	15.1	16.6



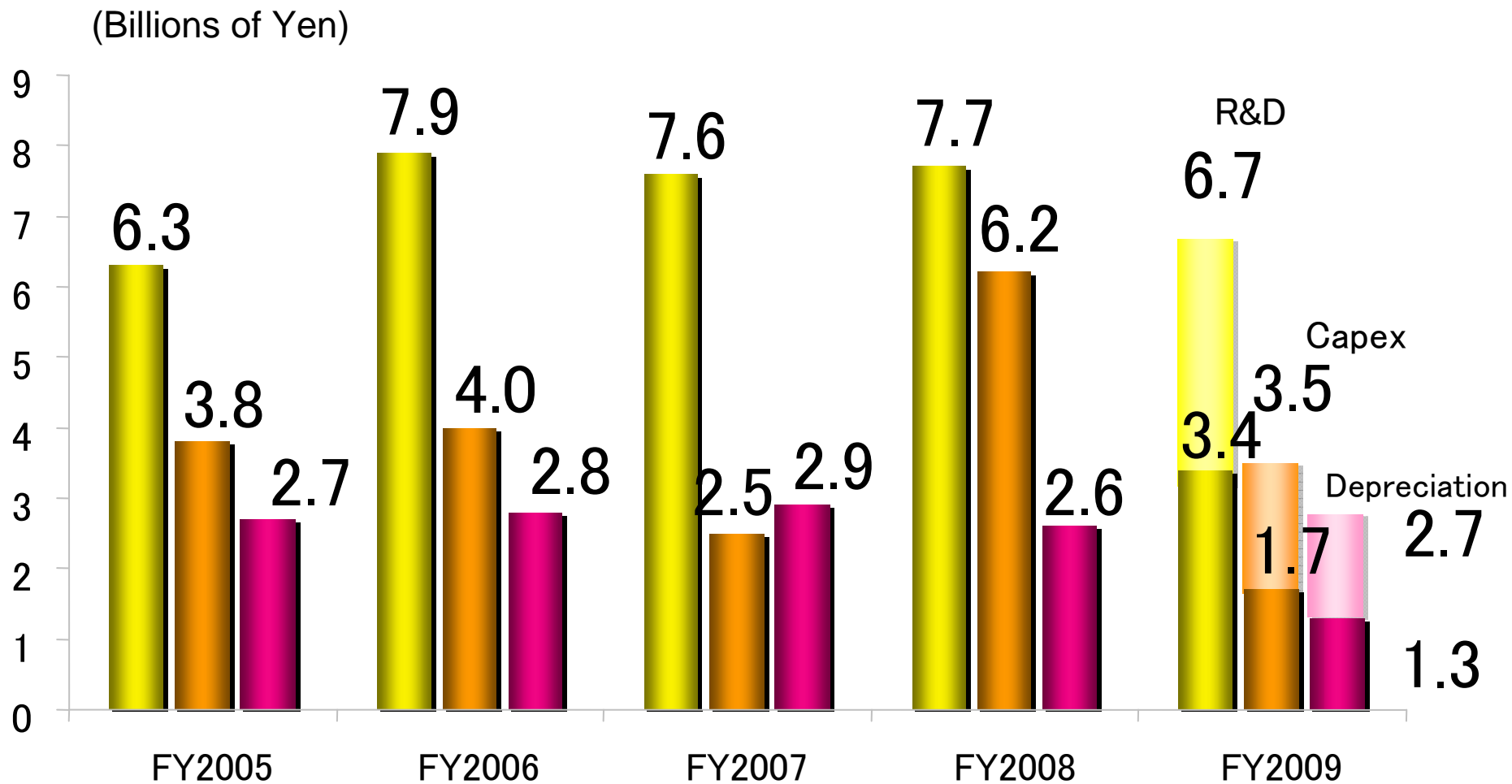
Financial Ratio

	(%)				
	FY05	0FY06	FY07	FY08	FY09 2Q
Shareholders' Equity Ratio	32.7	42.5	47.1	51.2	51.9

	(Times)				
	FY05	0FY06	FY07	FY08	FY09 2Q
Total Asset Turnover Ratio	0.9	0.9	0.9	0.8	0.6
Inventory Turnover Ratio	3.0	3.4	3.7	3.3	2.4



Forecast for R&D, Capex & Depreciation





Number of Employees

(Persons)

	9/07	3/08	9/08
Employees (Year End)	1,325	1,318	1,290
Temporary Employees (Average Number)	890	880	730
Total	2,215	2,198	2,020



Forecast for FY2009

Billions of Yen	FY08	FY09 As of 8/08			FY09 As of 11/08			Changes from previous year
		1H	2H	Full year	1H	2H	Full year	
Sales	91.8	32.0	33.0	65.0	31.8	21.2	53.0	△42.3%
Semiconductor	67.5	19.5	20.5	40.0	19.2	10.8	30.0	△55.6%
Metrology	24.4	12.5	12.5	25.0	12.6	10.4	23.0	△5.7%
Operating Income	10.45	2.40	2.60	5.00	2.13	△0.63	1.50	△85.6%
Ordinary Income	9.37	2.40	2.60	5.00	2.57	△1.47	1.10	△88.3%
Net Income	4.82	△0.40	1.40	1.00	△0.19	△1.41	△1.60	—
Dividend	70yen	15yen	25yen	40yen	15yen	10yen	25yen	—



Business Environment

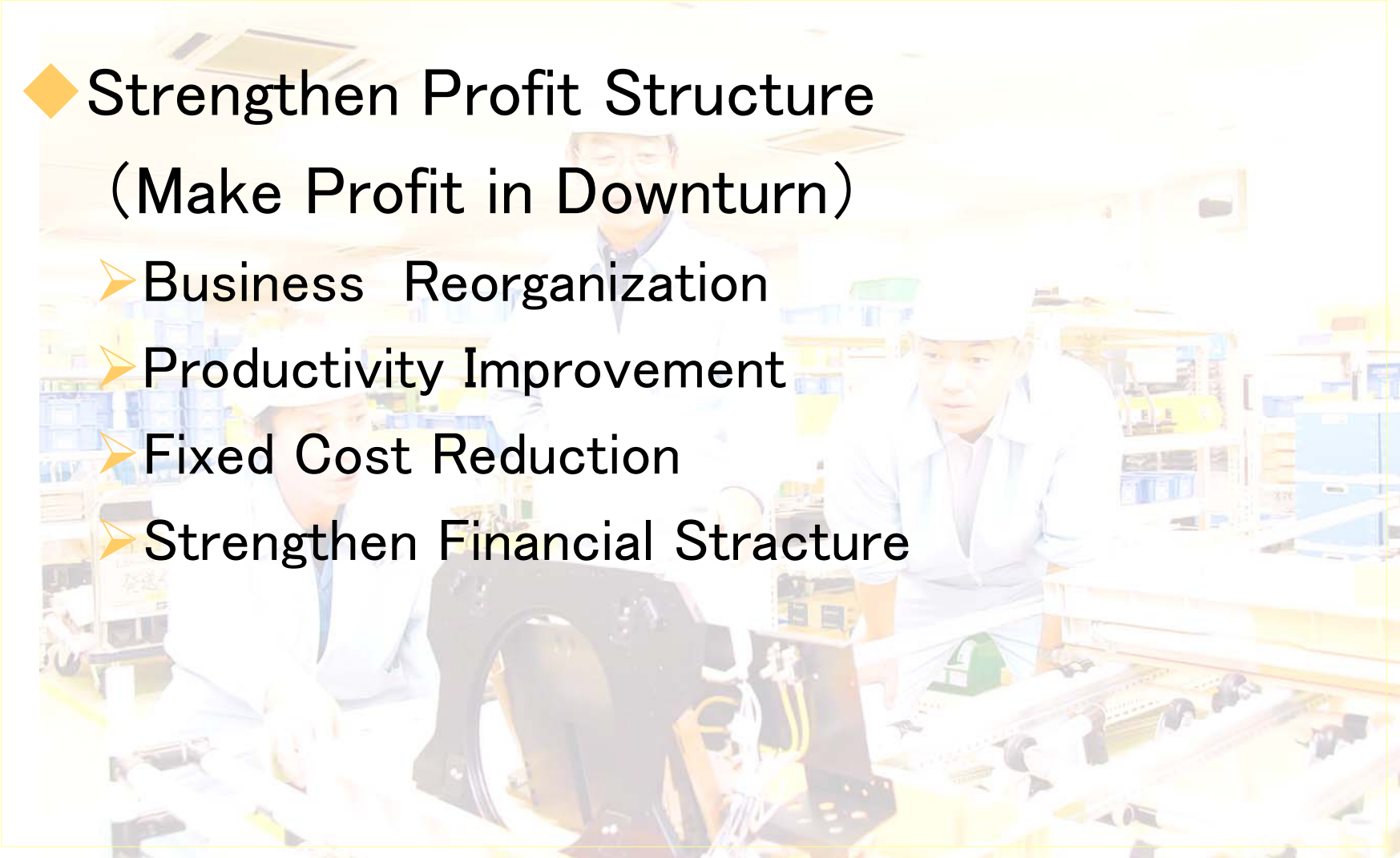
◆ Market Condition

➤ Semiconductor

- Overall Decline of Investment led by DRAM

➤ Measuring

- Decrease of Orders and Sales in Automobile and Machine Tool Industries

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- ◆ Strengthen Profit Structure
(Make Profit in Downturn)
 - Business Reorganization
 - Productivity Improvement
 - Fixed Cost Reduction
 - Strengthen Financial Structure



Growth Strategy

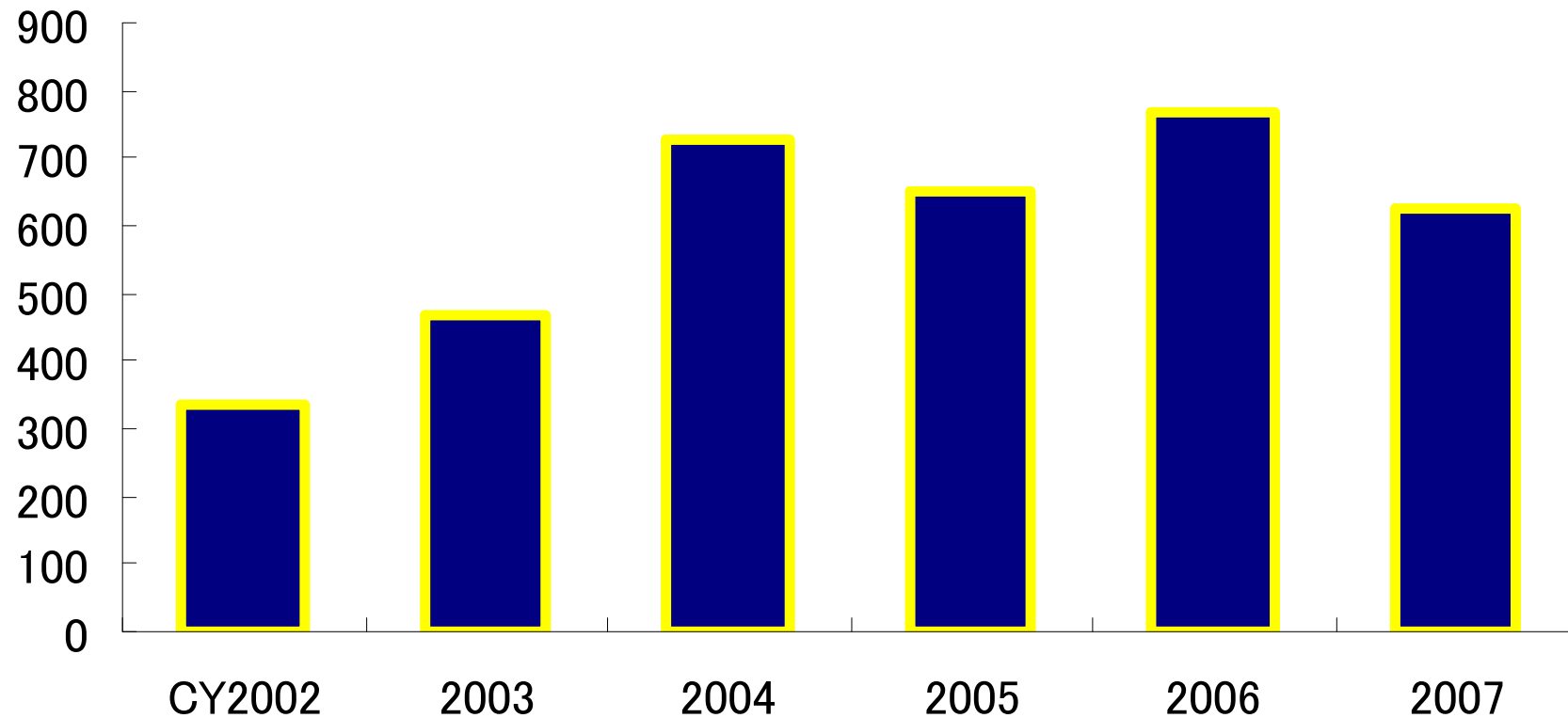
- ◆ Measures for Growth
 - Expand Core Businesses (Test Process ▪ Back-end Process ▪ Metrology)
 - Enhance Product Line-up
 - Market Share-up
 - Expand Services and Consumable Business
 - Develop New Products





Prober Market

(M USD)



Source: Gartner, Inc., "Forecast: Semiconductor Back-End Equipment, Worldwide, 4Q08 Update" 14 October 2008, GJ08571

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Prober Market Change and Our Countermeasure

● Market Changes



● Our Measure

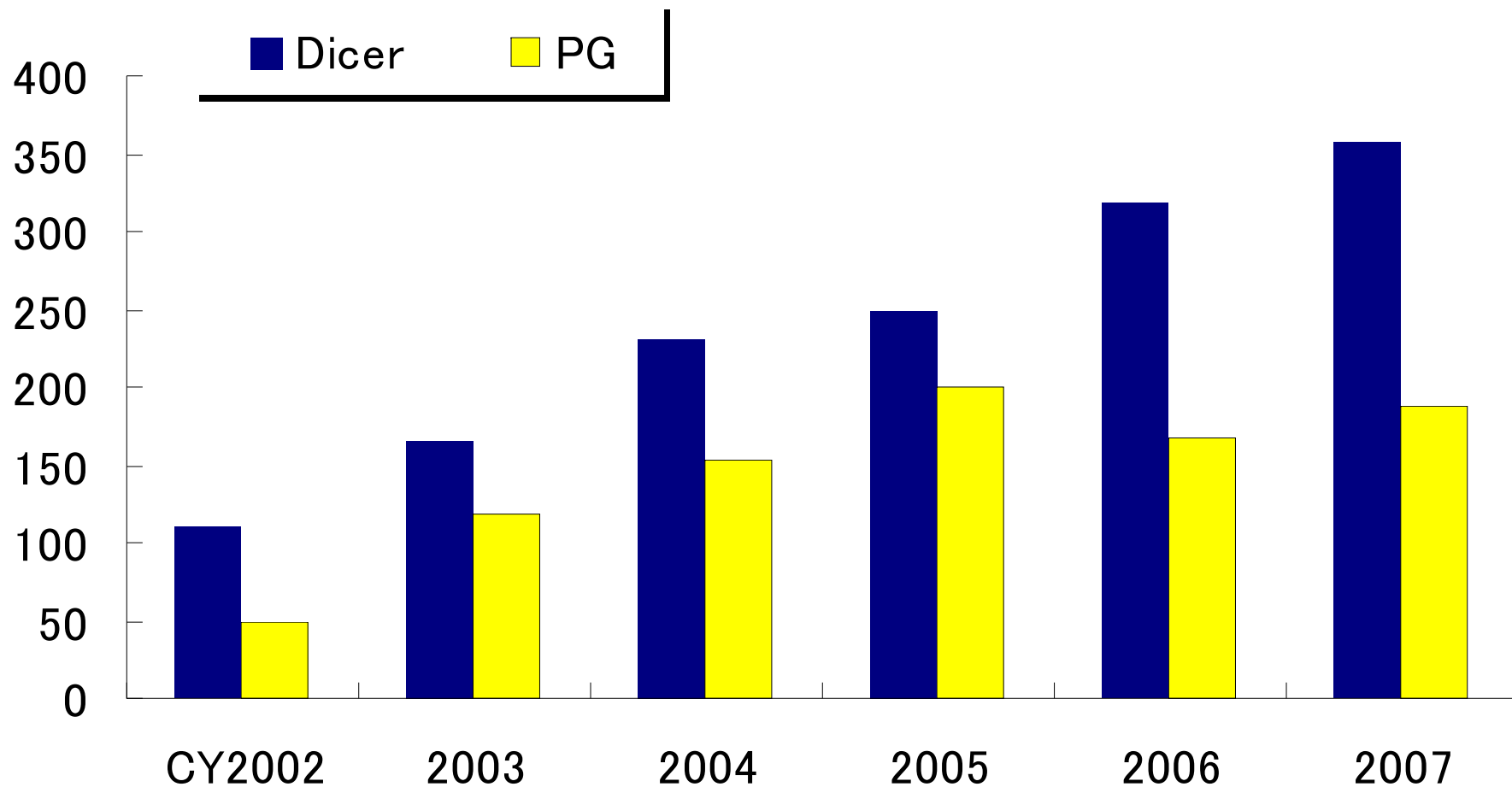
- Added Function
- Taking in from Packaging Test, etc.

- Joint-development with Semiconductor Manufacturers
- Lower Cost Models etc.



Dicer and PG Markets

(Millions USD)



Source : Tokyo Seimitsu



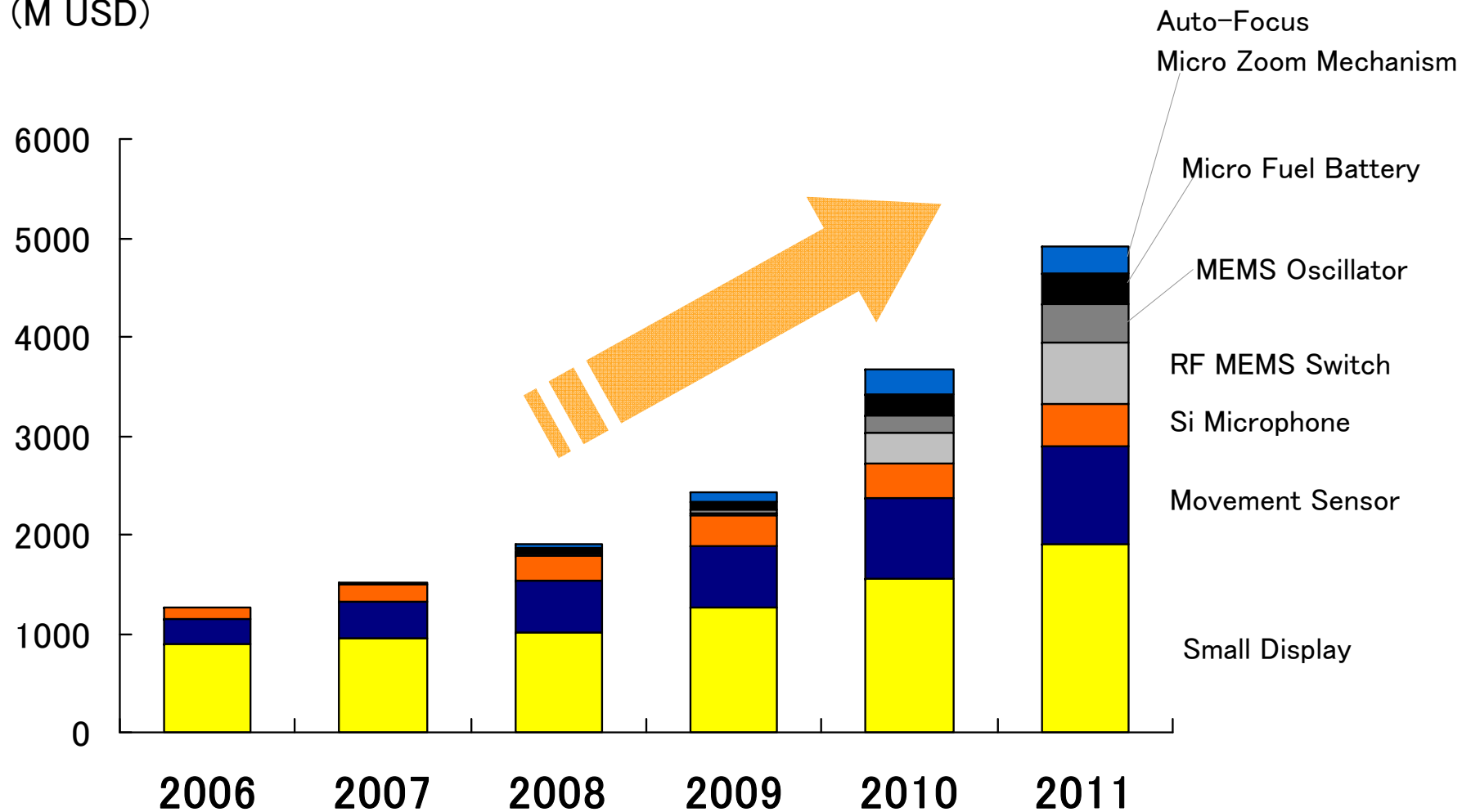
Product Strategy in Back-end Process





MEMS Market and Our Products

(M USD)



Source: Yole Developpement

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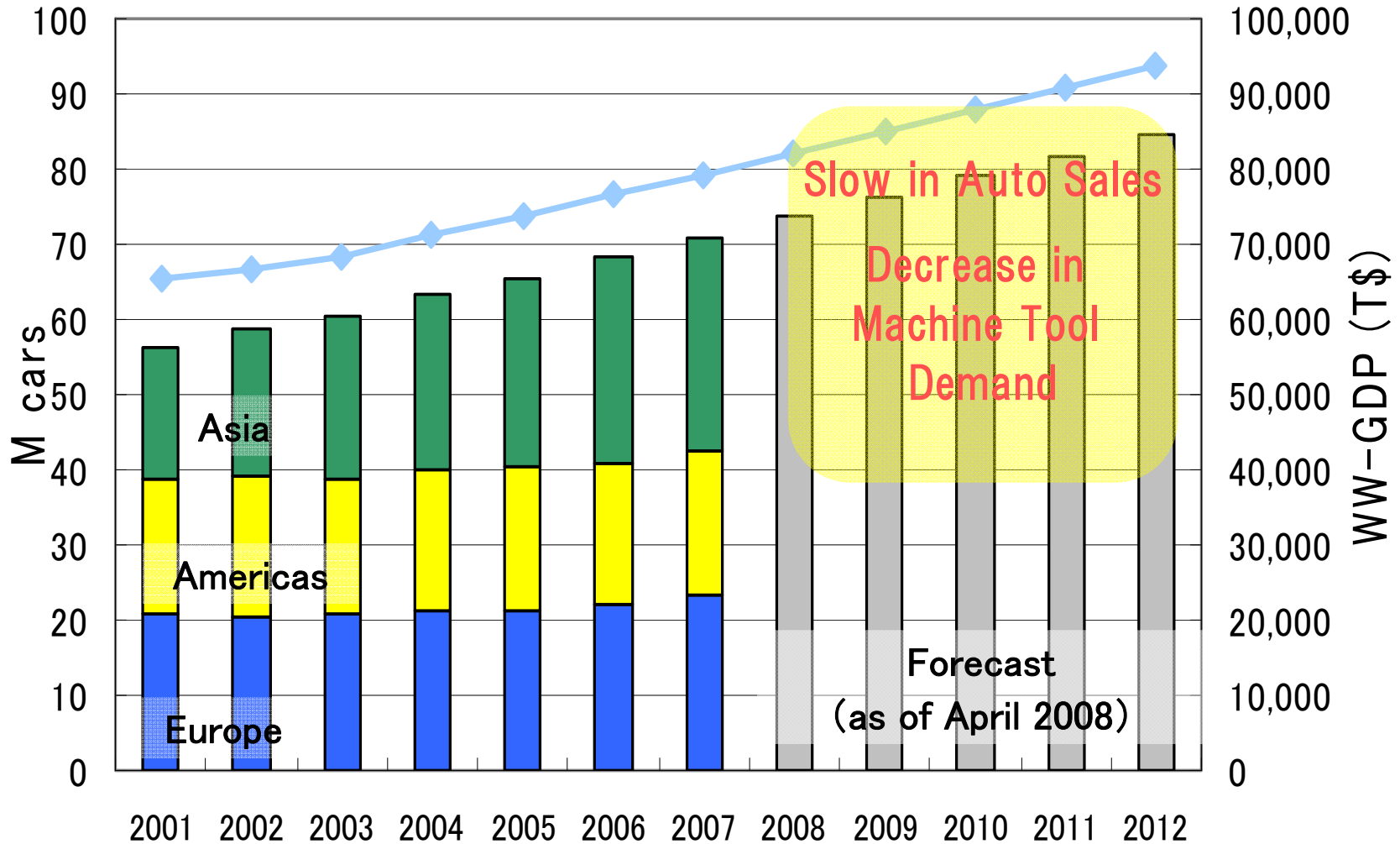
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Metrology Business: Market Condition

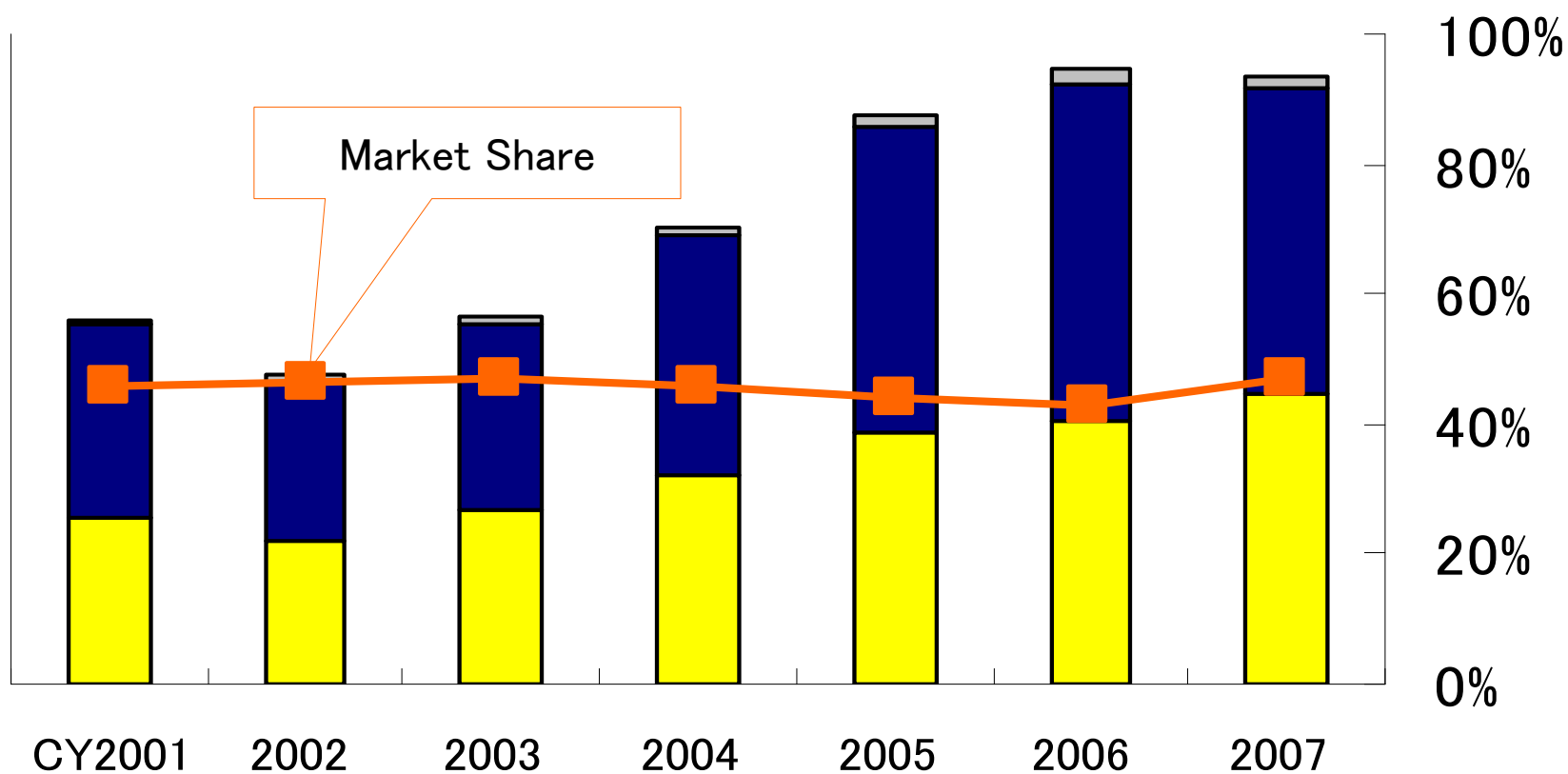
W/W GDP and Automobile Production





Multi-purpose Measuring Market

■ Tokyo Seimitsu ■ A ■ B





Metrology Business : Strategy

◆ Share up

- Market Development
- Overseas Market

◆ Eco Products

◆ Establishment of Global Brand



To increase our market share



Extra Large CNC 3D Coordinate Measuring Machines
“MMZ—B”

➤ Large Size
Measuring

➤ Overseas
Growing Markets

➤ New Products



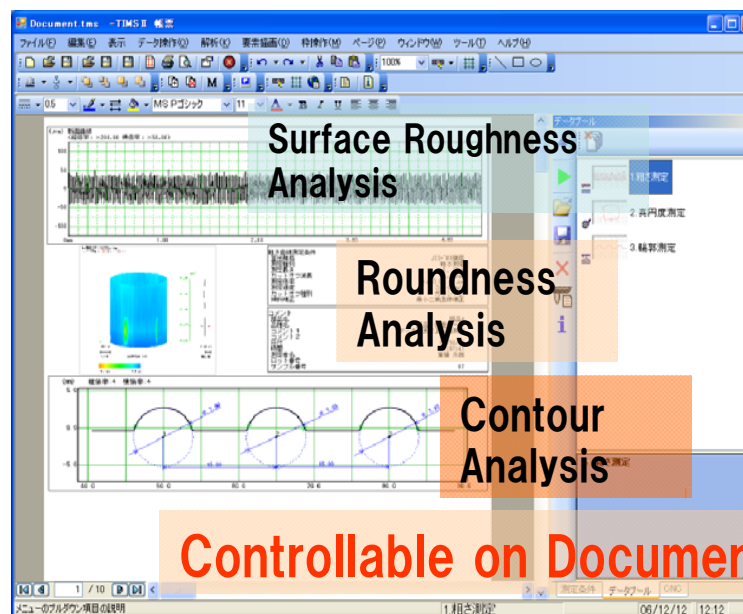
Newly Developed Integrated Software



Product Concept

- 1.Higher Usability with Simple Operation
- 2.Flexible and Best Software for field
- 3.Ample Support to Operators

ACCTee

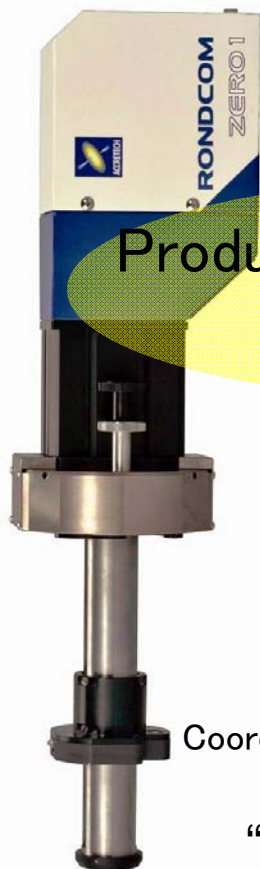


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Support Eco-friendly Society

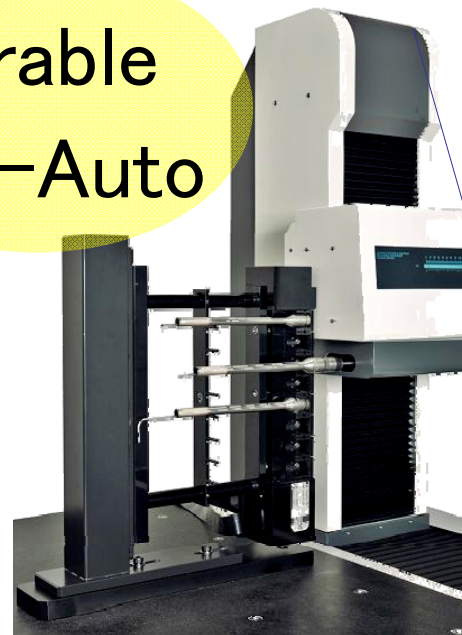
Cylindrical Form
Measuring Instrument
"RONDCOM
Zero1"



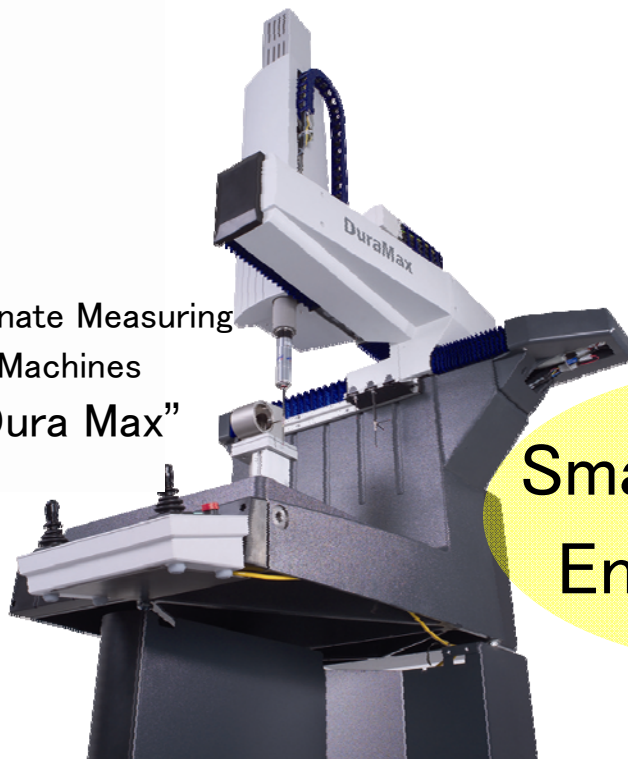
Production-floor Measuring
Space-saving

Durable
Full-Auto

Surface Texture and
Contour Measuring
Instruments
"SurfcomC5"
(ATC付)



Coordinate Measuring
Machines
"Dura Max"



Smaller footprint
Energy-saving





Message to the World, “Metrology Center”

Open!
28 November

ACCRETECH
METROLOGY
CENTER



Support World
“Manufacturing”
Integrated Center of
“Measuring”



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